

1. Features

- Typical 1dB bandwidth of 18.8 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

RoHS Compliant

Tested by SGS Testing Korea

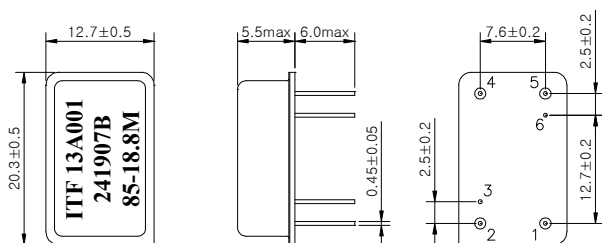
2. Electrical Specifications

Source and Load Impedance = 50Ω

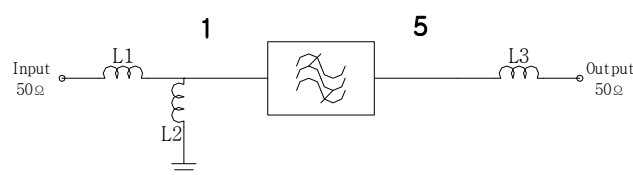
Room Temperature : +25℃		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	-	85.0	-
Insertion Loss	dB	84.91	85.0	85.09
1dB Bandwidth	MHz	18.75	18.87	-
3dB Bandwidth	MHz	-	19.17	-
45dB Bandwidth	MHz	-	20.50	20.60
Amplitude Ripple (Fo±9.22MHz)	dB	-	0.4	1.0
Group Delay Variation (Fo±9.22MHz)	nsec	-	40	100
Absolute Delay	usec	-	2.22	2.28
Ultimate Rejection	dB	50	55	-
Temperature Coefficient of Frequency	ppm/℃	-	-72	-
Substrate Material	-		128-LN	

* Input POWER : 10dBm

D2012 Package Dimension



Matching Schematic



L1 = 47nH, L2 = 270nH, L3 = 47nH

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated
 Cap : Cu & Cr Alloy, Ni Plated
 Termination : Kovar, Au Plated

Pin Configuration

	1	Ground	2,4
Input	1	Ground	2,4
Output	5	Others	Ground

3. Typical Performance (at +25°C)

